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SPECIFICATION FOR

LCD MODULE

MODULE NO.: ABC040002A05-BIW-R Customer NO.: REVISION: O

AVD	PREPARED BY	CHECKED BY	APPROVED BY
SIGNATURE	Yunqiang.Cai	Bibo.Xiong	Zhongkui.Ren
DATE	Mar-09-2022	Mar-09-2022	Mar-09-2022

	SIGNATURE	DATE
CUSTOMER APPROVAL		

Note:

This specification is subject to change without prior notice in order to improve performance or quality etc. please contact SHENZHEN AV-DISPLAY CO.,LTD to confirm the latest revision.

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秋田微电子 AVIDISIPLAY

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1. FUNCTIONS & FEATURES

- 1.1. Format
- 1.2. LCD mode
- 1.3. Viewing direction
- 1.4. Driving scheme
- 1.5. Power supply voltage (V_{DD})
- 1.6. LCD operating voltage
- 1.7. Operation temp
- 1.8. Storage temp
- 1.9. Backlight color

- : 40x2 characters
- : STN/Negative/Transmissive/Blue
- : 6 o'clock
- : 1/16 Duty , 1/5 Bias
- : 5.0V
- : 4.5V(reference voltage)
- :-20~70℃
- :-30~80°C
- : Edge, White

2. MECHANICAL SPECIFICATIONS

- 2.1. Module size
- 2.2. Viewing area
- 2.3. Character pitch
- 2.4. Character size
- 2.5. Dot pitch
- 2.6. Dot size
- 2.7. Weight

- : 182.00mm(PCB)(L)*33.50mm(PCB)(W)*14.00mm(max)(H)
- : 154.50mm(L)*15.80mm(W)
- : 3.70mm(L)*5.95mm(W)
- : 3.20mm(L)*5.55mm(W)
- : 0.65mm(L)*0.70mm(W)
- : 0.60mm(L)*0.65mm(W)
- : Approx. 91g

3. BLOCK DIAGRAM





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4. DIMENSIONAL OUTLINE



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5. PIN DESCRIPTION

No.	Symbol	Function
1	VSS	GND(0V)
2	VDD	Power supply(+5.0V)
3	V0	Supply voltage for LCD
4	RS	Register selection (H: Data register , L :Instruction register)
5	R/W	Read /write selection. (H: Read L: write)
6	E	Enable signal for chip
7~14	DB0~DB7	Data bus line
15	LEDA	Power supply for backlight(Constant Voltage:5.0V,<=70 mA)
16	LEDK	Power supply for Backlight(0V)

6. MAXIMUM ABSOLUTE LIMIT

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Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	VDD	-0.3	7.0	V
Supply Voltage for LCD	V0	VDD-12.0	VDD+0.3	V
Input Voltage	Vin	-0.3	VDD+0.3	V
Supply Current(without B/L)	IDD(Ta = 25°C)		3	mA
Supply Current for Backlight	IF(Ta = 25°C)		100	mA
Reverse Voltage for Backlight	VR(Ta = 25°C)		0.8	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Tst	-30	80	°C



7. ELECTRICAL CHARACTERISTICS

The Electrical characteristics are the characteristics of (AIP31066L) from the (AIP31066L)'s datasheet, more detials please refer to the datasheet of (AIP31066L).

7.1 DC characteristics

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(VDD=4.5~5.5V,Ta=-30℃~+80℃)

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit		
Operating Voltage	V _{DD}		4.5	-	5.5	V		
Supply Current	I _{DD}	Internal oscillation or external clock. (V _{DD} =5.0 V, fosc = 250 kHz)	12	0.55	0.8	mA		
Input Voltage (1)	V _{IH1}		2.5	-	V _{DD}	V		
(except OSC1)	V _{IL1}		-0.3	=	0.6			
Input Voltage (2)	V _{IH2}	12 A	V _{DD} -1.0	-	V _{DD}	V		
(OSC1)	V _{IL2}		-0.2		1.0			
Output Voltage (1)	V _{OH1}	I _{OH} =-0.205 mA	2.4	1	-	v		
(DB0 to DB7)	VOLI	$I_{OL}=1.2 \text{ mA}$	-	1.	0.4	, v		
Output Voltage (2)	V _{OH2}	$I_0 = -40 \text{ mA}$	0.9V _{DD}		-	V		
(except DB0 to	V _{OL2}	$I_0 = 40 \text{ mA}$	\	-	0.1V _{DD}	V		
Voltage Drop	V d _{COM}	I =1 0 1 m A	-	-	1	v		
	Vd _{SEG}	10-± 0.1 mA	-	-	1	v		
Input Leakage Current	I _{IKG}	$V_{IN} = 0$ V to V_{DD}	-1	, ÷	1	uA		
Input Low Current	IIL	$V_{IN} = 0 V, V_{DD} = 5 V (PULL UP)$	-50	-125	-250	10 07-02-0		
Internal Clock (external Rf)	f _{OSC1}	Rf=91 kΩ \pm 2% (V _{DD} = 5 V)	190	270	350	kHz		
	fosc		125	270	410	kHz		
External Clock	duty		45	50	55	%		
	t _R , t _F		-	-	0.2	ms		
COM ON resistance	R _{COM}	$I_0 = \pm 50 uA, V_{LCD} = 4.0 V$ COM1 - COM16			20	KO		
SEG ON resistance	R _{SEG}	$I_0 = \pm 50 uA$, $V_{LCD} = 4.0 V$ SEG1 - SEG40			30	122		
LCD Driving Voltage	V _{LCD}	V _{DD} -V ₅ (1/5, 1/4 Bias)	3.0	-	11.0	v		



7.2 AC characteristics

(VDD=4.5~5.5V,Ta=-30℃~+80℃)

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit
E Cycle Time	tc		500	-	-	
E Rise / Fall Time	t _R ,t _F		2	-	20	8
E Pulse Width (High, Low)	t _w		230	1	-	2
R/W and RS Setup Time	t _{sul}	(Pefer to Fig 1)	40	19		ns
R/W and RS Hold Time	t _{H1}	(Relef to Fig-1)	10		-	
Data Setup Time	t _{su2}	-	80		-	
Data Hold Time	t _{H2}	-	10	-		
E Cycle Time	t _e	Read Mode	500			ns
E Rise / Fall Time	t _R , t _F	(Refer to Fig-2)		-	20	
E Pulse Width (High, Low)	t _w		230			
R/W and RS Setup Time	t _{su}		40			1
R/W and RS Hold Time	t _H		10		-	
Data Output Delay Time	t _D	1	-	94	120	
Data Hold Time	t _{DH}		5	1	-	



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Figure 2 . Read Mode Timing Diagram

8. BACKLIGHT CHARACTERISTICS

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					-	Ta = 25°C			
ltem	Symbol	Condition	Min	Тур	Max	Unit			
Forward Voltage	Vf	IF=2*30mA	3.3	3.6	3.9	V			
Reverse Current	lr	Vr=0.8V		15		mA			
Reverse Voltage	Vr				0.8	V			
Luminous Intensity (Without LCD)	Lv	IF=2*30mA	450	600		cd/m ²			
Chromaticity Coordinate	X/Y	IF=2*30mA	X:0.26~0.32 Y:0.26~0.33						
Luminous Uniformity			≥75%						
Color		White							

Note: when the temperature exceed 25° C, the approved current decrease rate for backlight change as the temperature increase is: -0.36x4mA/°C based on the maximum absolute limiting current of the backlight,to make sure the backlight current<=min[2*30mA, 25*4-0.36*4*(Ta-25)mA] (below 25° C, the current refer to constant, which would not change with temperature).



9. ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit	
Operating Voltage	Vop	Ta = 25°C		4.5		V	
Bosponso timo	Tr	$T_2 = 25^{\circ}C$		150		ms	
Response line	Tf	Ta = 25 C		110		ms	
Contract	C r	Ta = 25°C		6			
Contrast	Ci	θx=θy=0		0			
	θx-			35		deg	
Viewing angle range	θχ+	$C \sim 2$		35		deg	
	θ у-	0123		40		deg	
	θν+			40		deq	







Note : Contrast Ratio (Cr)

• Positive Type

Contrast Ratio(Cr) =
$$\frac{\text{Brightness of non - selected waveform}(Bns)}{\text{Brightness of Selected waveform}(Bs)}$$

• Negative Type

Contrast Ratio(Cr) = $\frac{\text{Brightness of Selected waveform (Bs)}}{\text{Brightness of non - selected waveform}(Bns)}$

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10. CONTROL AND DISPLAY INSTRUCTION

				Inst	ructi	on C	ode	į.			Description	Execution
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	270 kHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM and set DDRAM address to '00H" from AC	1.53 ms
Return Home	0	o	o	0	0	o	0	0	1	-	Set DDRAM address to '00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	зн	Assign cursor moving direction and enable the shift of entire display.	39 µs
Display ON/ OFF Control	o	o	o	o	o	o	1	D	с	в	Set display(D), cursor(C), and blinking of cursor(B) on/off control bit.	39 µs
Cursor or Display Shift	0	0	o	o	0	1	s/c	R/L	-		Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 µs
Function Set	0	0	0	0	1	DL	N	F			Set interface data length (DL: 8-bit/4-bit), numbers of display line (N: 2-line/1-line) and, display font type (F:5×11dots/5×8 dots)	39 µs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 µs
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	ACO	Set DDRAM address in address counter.	39 µs
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	ACO	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 µs
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 μs
Read Data from RAM	1	1)	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43 µs

* "" dont care

Note: When an MPU program with checking the Busy Flag(DB7) is made, it must be necessary 1/2Fosc is necessary for executing the next instruction by the falling edge of the 'E' signal after the Busy Flag (DB7) goes to "Low".



11. FONT CHARACTERISTIC

V Upper																
4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
LLLL																
LLLH																
LLHL																
LLHH																
LHLL																
LHLH																
LHHL																
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HLLL																
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HHLH																
HHHL																
нннн																

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12. PRECAUTION FOR USING LCD/LCM

After reliability test, recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 30,000 hours

(average) under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}C$), normal humidity (below 65% RH), and in the area not exposed to direct sun light. Using LCM beyond these conditions will shorten the life time.

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged.Extreme care should be taken when handling.To clean dust or dirt off the display surface,wipe gently with cotton,or other soft material soaked with isoproply alcohol,ethyl alcohol or trichlorotriflorothane,do not use water,ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting AVD.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.

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- 3. Soldering temperature: 320±10°C
- 4. Soldering time: 0.6 to 3 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60% and avoid direct sunlight.

Limited Warranty

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AVD LCDs and modules are not consumer products, but may be incorporated by AVD's customers into consumer products or components thereof, AVD does not warrant that its LCDs and components are fit for any such particular purpose.

- The liability of AVD is limited to repair or replacement on the terms set forth below. AVD will
 not be responsible for any subsequent or consequential events or injury or damage to any
 personnel or user including third party personnel and/or user. Unless otherwise agreed in
 writing between AVD and the customer, AVD will only replace or repair any of its LCD
 which is found defective electrically or visually when inspected in accordance with AVD
 general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.



APPENDIX

I.LCM TEST CRITERIA

1. Objective

The LCM test criteria are set to formalize AVD's LCM quality standards with reference to those of the customer for inspection, release and acceptance of finished LCM products in order to guarantee the quality required by the customer.

2. Scope

The criteria are applicable to all the LCM products manufactured by AVD.

3. Equipments for Inspection

Electrical testing machines, vernier calipers, ampere meter, multi-meter, microscopes, antistatic wrist straps, finger cots, labels, tri-phase thermal shock chamber, constant temperature and humidity chamber, high-low temperature experimenting box, refrigerators, constant voltage power supply (DC), desk Lamps, etc.

4. Sampling Plan and Reference Standards

4.1.1 Sampling plan:

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Refer to National Standard GB/T2828.1-2012/ISO2859-1:1999, level II of normal levels:

Product Category	Non-consumer	Industrial	Automotive
			MA=0.15
AQL	MA=0.4 MI=1.0	WIA-0.25 WI-0.05	MI=0.40

- 4.1.2 GB/T 2828.1---2012/ISO2859-1:1999 Sampling check procedure in count.
- 4.1.3 GB/T 18910 Standard for LCM parts.
- 4.1.4 GB/T24213-2008 Basic Environmental Test Procedures for Electrical and Electronic Products...
- 4.1.5 IPC-A-610E Acceptability of Electronic Assemblies

5. Inspection Conditions and Inspection Reference

5.1 Cosmetic inspection: shall be done normally at 23±5°C of the ambient temperature and

45~75%RH of relative humidity, under the ambient luminance between 500lux~1000lux



and at the distance of 30cm apart between the inspector's eyes and the LCD panel and normally in reflected light. For backlight LCMs, cosmetic inspection shall be done under the ambient luminance less than 100lux with the backlight on.

5.2 The LCM shall be tested at the angle of 45°, left and right, and 0-45°, top and bottom (for STN LCM, at 20° -55°) :



5.3 Definition of VA

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A area: Display area (AA area)

B area: Viewing area (VA area)

C area: Non-viewing area (not viewing after customer assembly)

If there is any appearance viewing defect which do not affect product quality and customer assembly in C area, it's accepted generally.

The criteria apply to A and B area except chipping and crack.



- 5.4 Inspection with naked eyes (exclusive of the inspection of the physical dimensions of defects carried out with magnifiers).
- 5.5 Electrical properties: Inspection with the self-made/special LCM test jigs against the product documents or drawings; display contents and parameters shall conform to their documents requirements and the display effect to the drawing.



- 5.5.1 Test voltage (V) :(Determined) according to the operating instruction of test jigs assuming the external circuit can be adjusted unless the customer otherwise specifies driving voltage(s). (Display) effects are controlled within the specified range of voltage variation (If no specific requirements, display effects are controlled at Vop = 9V or Vop ±0.3V when Vop is below 9V; if Vop is above 9V, display effects are controlled at Vop ± 3% at least).For display products with the customer-specified fixed Vop, display effects are controlled by adjusting the internal circuit; if necessary, acceptable limit samples shall be built.
- 5.5.2 Current Consumption (1) : Refer to approved product specifications or drawings.
- 5.5.3 Size: for the outline dimension and the position which maybe affect customer assembled all should conform to the technical drawing requirements.

6. Defects and Acceptance Standards

6.1 Electrical properties test

No.	Defects	Description	Accepted standard	MAJ	MIN
6.1.1	Missing segment	Dot and character missing segment caused by its wire broken/poor contact(s) and internal open circuit.	Reject	\checkmark	
6.1.2	No display/ reaction	The products no picture display under normally connected situation.	Reject	\checkmark	
6.1.3	Mis-display/ abnormality display	Displaying pattern and sequence not conform to the requirement or abnormally display when scanning as per the correct procedure.	Reject	\checkmark	
6.1.4	Wrong viewing angle	When powered on, the clearest viewing direction of display pattern is not conform to the requested one(or not conform the direction of the customer approved samples)	Reject	\checkmark	
6.1.5	Dim or dark display	Overall contrast is either too dark or too dim under normal operation	Beyond the voltage tolerance, reject	\checkmark	
6.1.6	Response slowly	When power on or off some parts response time is different from others.	Reject	\checkmark	
6.1.7	Exceed	As misalignment and insufficient etching	Refer to the		
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	segment	caused abnormally display, display with exceed pattern or display with abnormally symbol, row or columns when power on.	dot/line standard		
6.1.8	PI black/ white spot	Partial black and white spots visible when changing display contents due to defective PI layer.	Refer to the spot/line criteria for the visible spots when display image remains still; others OK		\checkmark
6.1.9	Pinhole /white spot	Fragmental patterns appearing when it powered on caused by missing ITO. $\bigoplus_{k=1}^{\infty} \bigoplus_{k=1}^{\infty} \bigoplus_{k$	Refer to the dot/line standard		\checkmark
6.1.10	Pattern distortion	The pattern displayed width is either wider, narrower or deformed than the specified, caused by its misalignment and resulting in unwanted heave(s) or missing: la- lb ≤1/4W(W is the normal width)	la-lb >1/4W, Reject		\checkmark
6.1.11	Voltage	When normally working the bias between measured voltage and designed voltage is more than $\pm 4\%$ (if at or below 5V, inspect at the tolerance of +/-0.2V)	Reject	\checkmark	
6.1.12	High current	The current of LCD is higher than the standard one.	Reject		

6.2 LCD appearance defect:

6.2.1 Dot and line defects (defined within VA, spots out of VA do not account)

			Acceptable quantity				
NO.	Items	Average diameter (d)	VA≤600 mm2	600mm2< VA≤5000 mm2	5000mm2 <va≤20000 mm2</va≤20000 	MAJ	MIN
6.2.1.1	Spot defects	d≤0.10	Not counted	Not counted	Not counted		
	material, nick,	0.10 <d≤0.20< td=""><td>3</td><td>3</td><td>1</td><td></td><td>\checkmark</td></d≤0.20<>	3	3	1		\checkmark
	including LC with	0.20 <d≤0.25< td=""><td>0</td><td>1</td><td>4</td><td></td><td></td></d≤0.25<>	0	1	4		

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	wrong			•]	
	orientation)	0.25 <d≤0.30< td=""><td>0</td><td>0</td><td></td><td>1</td><td></td><td></td></d≤0.30<>	0	0		1		
		0.30 <d≤0.40< td=""><td>0</td><td>0</td><td></td><td>0</td><td></td><td></td></d≤0.40<>	0	0		0		
		0.40 <d< td=""><td>0</td><td>0</td><td></td><td>0</td><td></td><td></td></d<>	0	0		0		
	Line defects	W≤0.01	Not counted	Not counted				
6.2.1.2	linear foreign materials)	L≤2.0, W≤ 0.02	2	3	No	t counted		
		L≤3.0, W≤0.03	1	2		3		\checkmark
		L≤3.0, W≤0.05	0	1		2		
	Line length=L Line width=W	Note: when W>0.1mm it can regard as spot defect.						
	Polarizer with air bubble or	d≤0.15	Not counted	Not count	ed	Not counted		
	convex-concave	0.15 <d≤0.3< td=""><td>2</td><td>3</td><td></td><td>2</td><td rowspan="2"></td><td></td></d≤0.3<>	2	3		2		
		0.3 <d≤0.5< td=""><td>1</td><td>2</td><td></td><td>5</td><td></td></d≤0.5<>	1	2		5		
6.2.1.3		0.5 <d≤0.8< td=""><td>0</td><td>1</td><td></td><td>2</td><td></td><td>\checkmark</td></d≤0.8<>	0	1		2		\checkmark
		0.8 <d≤1.0< td=""><td>0</td><td>0</td><td></td><td>1</td><td></td><td></td></d≤1.0<>	0	0		1		
		1.0 <d< td=""><td>0</td><td>0</td><td></td><td>0</td><td></td><td></td></d<>	0	0		0		

Notes:

1.It is prohibited to have 5 areas of dot or line defects, and the distance between each other should ≥5mm.

2.VA area is 5000mm², which apply to 4~4.5 inches, and it is for 20 modules. 600mm² is for 1.4 inches of 200 modules.

3. Once area of VA exceeds 20000mm²(about 8inches, 6modules),it needs to redefine standard of dot and line.

6.2.2 Glass Damages (for LCMs without bezels and whose LCD edges exposed and for LCMs with bezels, including COG, H/S and directly assembled with BL LCMs)

No.	Defects	Accept	Acceptable standard (unit: mm)				MIN
No. 6.2.2.1	Chipping on the conductive ITO side	Х	/	≤1/8L	/		
		Y	Y≤1/6 W	1/6W <y≤1 4w<="" td=""><td>1/4W <y< td=""><td></td><td>\checkmark</td></y<></td></y≤1>	1/4W <y< td=""><td></td><td>\checkmark</td></y<>		\checkmark
		Acceptable quantity	2	2	0		

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6.2.2.2	Corner chipping (ITO	' X	/	≤1/6L	/		
	pins position)	Y	Y≤1/2 W	1/2W <y≤w< td=""><td>W <y< td=""><td></td><td></td></y<></td></y≤w<>	W <y< td=""><td></td><td></td></y<>		
		Acceptable quantity	2	1	0		
	Z T X X	Corner chipp position as p should not e and the corn connection p	oing occur er 6.3.3; a nter into b er chippin osition pe	red in sealed e at the same tim lack border of f g effect the ele rform as per 6.	dge e it the frame ctric 3.1.		
	Chipping in sealed	Х	1	≤1/8L	/		
	chipping)	Y(outside chipping)	not enter	enter into ≤H	H <y< td=""><td></td><td></td></y<>		
6.2.2.3	X Y X Y X Y Y Y Y Y Y Y Y Y Y Y Y Y Y Y	Y (inside chipping)	Into black border of the frame	enter into ≤1/2H	1/2H <y< td=""><td></td><td>\checkmark</td></y<>		\checkmark
		Acceptable quantity	2	1	0		
	Chipping in sealed area (inside chipping)	H: width of th	ne sealant				
	Chipping on the	Х	/	≤1/6L	/		
	conductive ITO.	Y	Y≤1/3W	1/3W <y≤2 3w<="" td=""><td>2/3W <y< td=""><td></td><td></td></y<></td></y≤2>	2/3W <y< td=""><td></td><td></td></y<>		
6.2.2.4		Acceptable quantity	2	2	0		\checkmark
		If the chipping extend to the ITO side, as per 6.3.1					
	Protruding LCD, poor	Х	/	≤1/8L	/		
	burrs	Y	≤1/6W	1/6₩ <y≤1 5w<="" td=""><td>1/5W <y< td=""><td></td><td></td></y<></td></y≤1>	1/5W <y< td=""><td></td><td></td></y<>		
6.2.2.5		Z	/				
		Acceptable quantity	1	1			
		the outside p tolerance of	orotruding drawing.	control as per	the		

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There should not allow to occur cracks without direction; the crack expand to inside is NG, but to outside is OK (confirmed as per the damaged standard)

Note: 1) X means the length of chipping; Y means the width; Z means the thickness; W means the step width of the two glasses; H: width of the sealant; t indicates glass thickness.

6.2.3 Others

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.2.3.1	Rain ball/ bottom color	There is two different color in the same one product or the same batch products with two different colors	Reject or refer to the limited samples		
6.2.3.2	Leaking ink (LC)	/	Reject	\checkmark	
6.2.3.3	Without protect film	/	Reject		\checkmark
6.2.3.4	Splay mark	Inspecting whether the surface of polarizer with splay marks against the light	Refer to the limited samples		\checkmark

6.3 Backlight components:

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.3.1	Backlight not working, wrong color	1	Reject	\checkmark	
6.3.2	Color deviation	When powered on, the LCD color differs from its sample and found that the color not conforming to the drawing after testing.	Refer to sample and drawing		\checkmark
6.3.3	Brightness deviation	When powered on, the LCD brightness differs from its sample and is found after testing not conforming to the drawing; or if it conforms to the drawing but the brightness over ±40% than its typical value.	Refer to sample and drawing		V
6.3.4	Uneven brightness	When powered on, the LCD brightness is uneven on the same LCD and out of the specification of the drawing. The no specification	Refer to sample and drawing		

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		evenness= (the max value- the min value)/ mean value< 70%.			
6.3.5	Spot/line scratch	When power on, it with dirty spot, scratches and so on spot and line defects	Refer to 6.2.1		\checkmark
6.3.6	BL wrapped	The BL should paste tightly on the PCB.	The BL can be allowed within 1mm wrapped parts, if them not affect its appearance and outline dimension.		V
6.3.7	Flicker and with LED shade	When power on, each bright source should not with flicker and the brightness should evenness and without LED shades.	Reject	\checkmark	

6.4 Metal frame (Metal Bezel)

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.4.1	Material/surface treatment	Metal frame/surface treatment do not conform to the specifications.	Reject	\checkmark	
6.4.2	Tab twist inconformity/ Tab not twisted	Wrong twist method or direction and twist tabs are not twisted as required.	Reject	\checkmark	
6.4.3	Oxidization	Oxidation on the surface of the metal bezel	Reject		\checkmark
6.4.4	Painting peel off, discoloration, dents, and scratches	 the front surface with painting peel off and scratched can be see the bottom: Dot : D≤0.5mm, exceeds 3; Line: length ≤3.0mm, width ≤0.05mm , exceeds 2; front dent, air bubble and side with painting peel off which scratched can be see the bottom: Dot: D≤1.0mm, exceeds 3; Line: length ≤3.0mm, width ≤0.05mm, exceeds 2. 	Reject		\checkmark
6.4.5	Burr	Burr(s) on metal bezel is so long as to get into viewing area.	Reject		



6.5 PCB/COB

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.5.1	Improper Epoxy Cover	 Contacts exposure within the white circle for COB chip bonding. The height of epoxy cover is out of the product specifications and drawing. The epoxy cover over the COB chip exceeds the circle by more than 2mm in diameter, which is the maximum distance the epoxy cover is allowed to exceed the circle. Existence of obvious linear mark(s) or chip-exposing pinhole on the epoxy cover. The pinhole diameter on the epoxy over exceeds 0.25mm and there is foreign matter in the pinhole. 	Reject		V
6.5.2	PCB appearance defect	 Oxidized or contaminated gold fingers on PCB. Bubbles on PCB after reflow-soldering. Exposure of conductive copper foil caused by peeled off or scratched solder-resist coating. For the conductive area of PCB repaired with the solder resist coating material, the diameter ψ of the repaired area on the circuit must not exceed 3mm while for the non-conductive area of PCB repaired with the solder resist coating material, the diameter ψ must not exceed 2.6mm; the total number of repaired areas on PCB must be less than 10; otherwise, the PCB must be rejected. 	Reject		V
6.5.3	Wrong or missing Component s on PCB	 Components on PCB are not the same as defined by drawing such as wrong, excessive, missing, or mis-polarized components. (The bias circuit of LCD voltage or the backlight current limiting resistance is not adjusted unless specified by the customer.) 	Reject	V	

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 The JUMP short on PCB shall conform to the mechanical drawing. If excessive or missing soldering occurs, the PCB shall be rejected. 		
 For components particularly required by the customer and specified in the mechanical drawing and/or component specifications, their specifications must conform to those of the suppliers; otherwise they shall be rejected. 		

6.6 Connector and other components

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.6.1	Out of Specification	The specification of connector and other components do not conform to the drawing.	Reject		\checkmark
6.6.2	Position and order	Solder position and Pin# 1 should be in the positions specified by the drawing.	Solder position and Pin# 1 should be in the positions specified by the drawing.		\checkmark
6.6.3	Appearance	 Flux on PCB components and pins. The pin width of a PIN connector exceeds ½ of the specified pin width. 	Reject		\checkmark
6.6.4	Glue amount	Flat cable connector: as the conducted wire fixed with glue, if the glue not fully covered the exposed wire and the copper part around holes will be rejected.	Reject		\checkmark
6.6.5	Through holes blocked	Socket connector: the components can not plug-in units as the through holes blocked and deformation; the locks which with lock catch can not make the external connector to be locked.	Reject		\checkmark

6.7 SMT (Refer to IPC-A-610E the second standard if not specified)

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.7.1	Soldering solder defects	Cold, false and missing soldering, solder crack and insufficient solder dissolution.	Reject		\checkmark
6.7.2	Solder ball/splash	Solder ball/tin dross causing short circuit at the solder point. There are active solder ball and splash.	Reject		



6.7.3	DIP parts	Floated or tilted DIP parts, keypad, and connectors.	Reject	
6.7.4	Solder shape	The welded spot should be concave and excessive or insufficient solder or solder burr on the welded spot must be rejected.	Reject	
6.7.5	Component pin exposure	For the DIP type components, 0.5~2mm component pin must be remained after cutting the soldered pin and the solder surface neither should not be damaged nor should the component pin is fully covered with solder; otherwise rejected.	Reject	\checkmark
6.7.6	Poor Appearance	The LCMs become yellow-brown or black as the residual resin or solder oil. There is white mist residual at the solder point caused by PCB cleaning.	Reject	

Anything which is not clearly defined in 6.5~6.7 should refer to IPC-A-610E.

6.8 Hot Pressing components	(including H/S,	FPC, etc.)
	(

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.8.1	Out of its specification		Reject	\checkmark	
6.8.2	Size		Refer to its drawing		\checkmark
6.8.3	Position	h h h h h h h h h h h h h h	 If f≤1/3w, h≤1/3H, and its conform to the size and specification on drawing, which will be received. The contact area of dielectric material conductor position and pressing material over 1/2 (controlling as per each ITO position) will be received. 		\checkmark

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6.8.4	Foreign Matter in Hot pressing area	If foreign matter in non- conductive heat compression area shall not cause short, it is OK. If foreign matter in conductive heat compression area does not exceed 50% of the heat pressure area, it is OK.	Receive		\checkmark
6.8.5	Fold marks		Refer to the limited samples.		\checkmark
6.8.6	Tension/ pulling force	Normally pulled up at a 90 degree angle vertical to PIN	Heat seal paper: larger than 350 g/cm FPC: larger than 700 g/cm	\checkmark	

6.9 General Appearance

No.	Defects	Description	Acceptance standard	MAJ	MIN
6.9.1	Connection material	Damaged or contaminated FPC or H/S gold fingers or FFC contact pin side with exposed copper foil or base materials. Sharp folds on FPC, FFC, COF, H/S (unless designed for). Solder paste larger than 2/3 of pin width on the gold finger of FPC and PCB. Pierced or folded FPC/FFC exceeding limit sample.	Reject		V
6.9.2	Poor reinforcing band	The protect tape using for reinforce which not complete covered the needed protection circuits (such as H/S, FFC, FPC, etc.) or it not joint with its pasted material or it glued on the output side of pins.	Reject		
6.9.3	Surface dirt	The surface of finished LCMs with smudge, residual glue, and finger prints, etc; solder spatters or solder balls on non-soldered area of PCB/COB. Non-removed defect mark or label on LCMs.	Reject		V
6.9.4	Assembly black spot	Smears or black spots found on LCMs after backlight or diffusion barrier are assembled.	Refer to 6.2.1		\checkmark
6.9.5	Product	Missing, unclear, incorrect, or misplaced	Reject		\checkmark

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	mark	part numbers and/or batch marks.		
6.9.6	Inner packing	Packing being inconsistent with quantity and part number on packing label, specifications or the customer order - either short-packed or over-packed.	Reject	
6.9.7	Dimension	According to drawing		

Notes: The criterion apply to all kinds of LCM products, ignore the related articles if product doesn't contain the components which are defined in 6.3~6.9.

7. Reliability Test

Test item	Condition	Time(hrs)	Sample	Acceptance		
i est item	Condition		quantity	standard		
High Storage Temp.	80 ℃		3			
High Operating	70 °C	•	3	-		
Low Storage Temp.	-30 ℃	•	3	-		
Low Operating	-20 ℃	240hrs	3	Functions and		
Temp& Humidity Test	60℃,90%RH		3	appearance are qualified before an after test		
Thermal Shock	-30℃(30min)←25℃(10min) →80℃(30min), and raising its temperature 5℃/min	40 cycles	3			
Note:The temperature allowable deviation is $\pm5^\circ\!\!\mathbb{C}$ and the humidity allowable deviation is $\pm5^\circ\!\!\mathbb{R}$ H.						



8. Packing

- 8.1 The acceptance inspection of product packing shall meet design requirements. The product packaging label shall bear not only product name, part number, quantity, product date code but also QA's qualifying stamp for each production stage. Incomplete or wrong label shall be unacceptable.
- 8.2 When there are problems with packing safety conformity such as shock resistance, moisture resistance, anti ESD and press resistance, packing shall be disqualified.
- 8.3 When customer's special requirements for packing confirmed and accepted by AVD, packing shall be inspected and released according to them.
- 8.4 RoHS and non-RoHS compliant products shall be labeled clearly and separately. Unless otherwise specified by the customer, "RoHS" labels shall be used for all RoHS compliant products.

9. Others

9.1 Items not specified in this document or released on compromise should be inspected with reference to mutual agreement and limit samples.

II.HSF compliance

This products complies with ROHS EU 2015/863、REACH 1907/2006/EC requirements, and the packaging complies with 94-62-EC.